

PC3Q65

High Sensitivity Type Half Pitch Photocoupler

■ Features

1. Half pitch, 4-channel surface mount type for high density mounting (Lead pitch:1.27mm)
2. High sensitivity (darlington type)
3. Soldering reflow type (230°C, for 30s)
4. Taping package
5. Isolation voltage (Viso (rms):2.5kV)
6. Recognized by UL, file No. E64380

■ Applications

1. Programmable controllers
2. Facsimiles
3. Telephones

■ Package Specifications

Model No.	Package specification
PC3Q65	Taping reel diameter 330mm (1 000pcs.)

■ Absolute Maximum Ratings (Ta=25°C)

	Parameter	Symbol	Rating	Unit
Input	*1 Forward current	I_F	50	mA
	*2 Peak forward current	I_{FM}	1	A
	Reverse voltage	V_R	6	V
	*1 Power dissipation	P	70	mW
Output	Collector-emitter voltage	V_{CEO}	35	V
	Emitter-collector voltage	V_{ECO}	6	V
	Collector current	I_C	80	mA
	*1 Collector power dissipation	P_C	150	mW
	*1 Total power dissipation	P_{tot}	170	mW
	Operating temperature	T_{opr}	-30 to +100	°C
	Storage temperature	T_{stg}	-40 to +125	°C
	*3 Isolation voltage	$V_{iso (rms)}$	2.5	kV
	*4 Soldering temperature	T_{sol}	260	°C

*1 The derating factors of absolute maximum ratings due to ambient temperature are shown in Fig.2 to 5

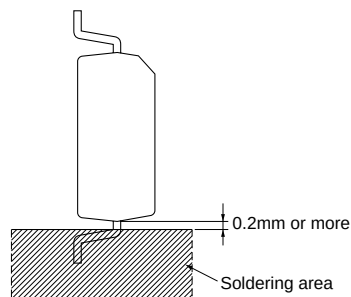
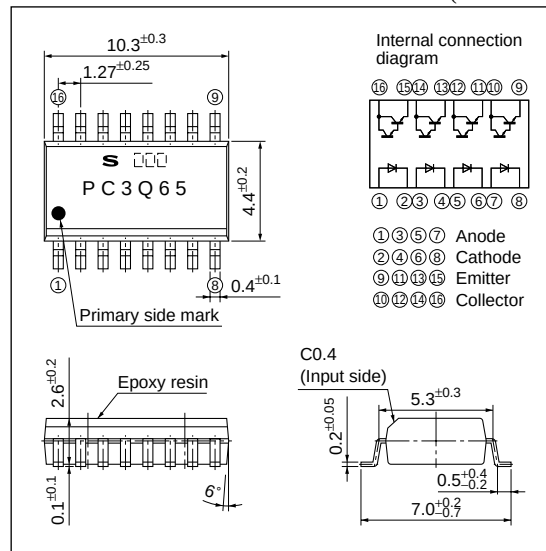
*2 Pulse width≤100μs, Duty ratio=0.001(shown in Fig.6)

*3 40 to 60%RH, AC for 1 min, f=60Hz

*4 For 10 s

■ Outline Dimensions

(Unit : mm)



Electro-optical Characteristics				(Ta=25°C)			
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	VF	IF=20mA	—	1.2	1.4	V
	Reverse current	IR	VR=4V	—	—	10	μA
	Terminal capacitance	Ct	V=0, f=1kHz	—	30	250	pF
Output	Collector dark current	ICEO	VCE=10V, IF=0	—	—	1000	nA
	Collector-emitter breakdown voltage	BVCEO	IC=0.1mA, IF=0	35	—	—	V
	Emitter-collector breakdown voltage	BVECO	IE=10μA, IF=0	6	—	—	V
Transfer characteristics	Collector current	IC	IF=1mA, VCE=2V	6	16	75	mA
	Collector-emitter saturation voltage	VCE(sat)	IF=1mA, IC=2mA	—	0.8	1.0	V
	Isolation resistance	RISO	DC500V, 40 to 60%RH	5×10 ¹⁰	10 ¹¹	—	Ω
	Floating capacitance	Cf	V=0, f=1MHz	—	0.6	1.0	pF
	Response time	Rise time	VCE=2V IC=2mA RL=100Ω	—	60	300	μs
		Fall time		—	53	250	μs

Fig.1 Forward Current vs. Ambient Temperature

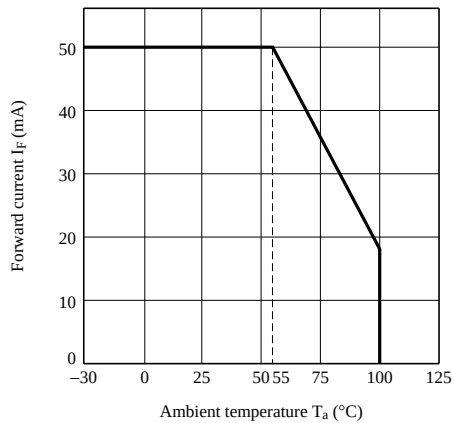


Fig.2 Diode Power Dissipation vs. Ambient Temperature

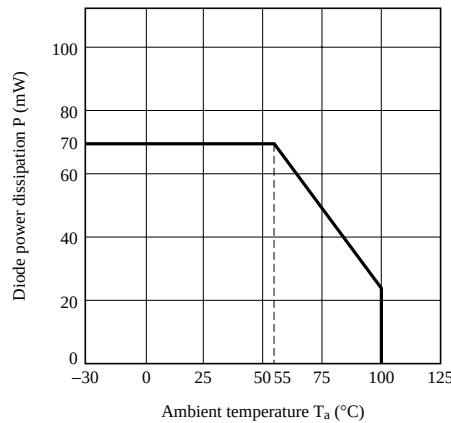
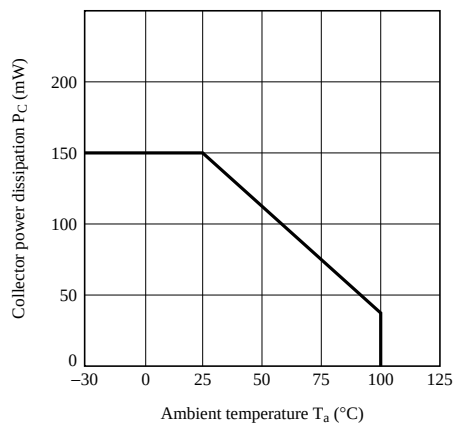
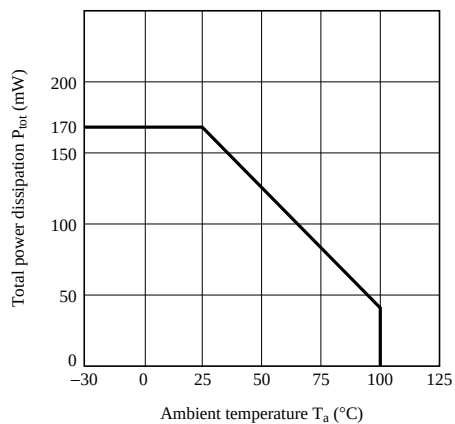
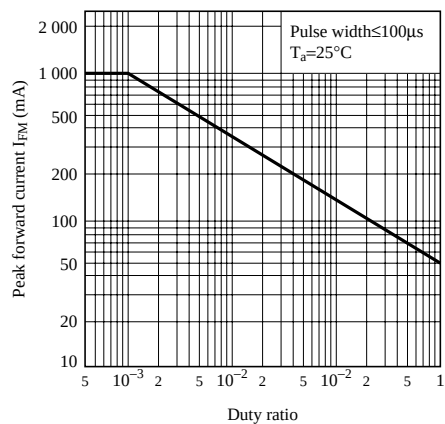


Fig.3 Collector Power Dissipation vs. Ambient Temperature**Fig.4 Total Power Dissipation vs. Ambient Temperature****Fig.5 Peak Forward Current vs. Duty Ratio**

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